

# 4DLCD-32320240 Series



4DLCD-32320240-RTP

4DLCD-32320240-CTP

4DLCD-32320240-CTP-CLB

## Datasheet

Revision 1.3

Copyright © 2023 4D Systems

Content may change at any time. Please refer to the resource centre for latest documentation.

# Contents

---

1. General Specification	3
2. TFT LCD Display Drawing (Non-Touch Version)	6
3. TFT LCD Display Drawing (Resistive Touch Version)	7
4. TFT LCD Display Drawing (Capacitive Touch Version)	8
5. TFT LCD Display Drawing (Capacitive Touch Version with Cover Lens Bezel)	9
6. Absolute Maximum Ratings	10
7. Electrical Characteristics	10
8. Electro-Optical Characteristics	11
9. Backlight Characteristics	12
10. Interface Descriptions	14
10.1. LCD Interface	14
10.2. CTP Interface	16
11. Backlight Example Circuit	17
12. Initialisation Code	18
13. LCD Timing Details	20
13.1. Timing Chart	20
13.2. Reset Timing	21
13.3. Power On Sequence	22
13.3.1. Case 1 - RES line is held High or Unstable by Host at Power ON	22
13.3.2. Case 2 - RES line is held Low by Host at Power ON	22
13.4. Power-off Sequence - Uncontrolled Power Off	22
14. Reliability Test	23
15. Precautions for Using LCD Modules	24
15.1. Handling Precautions	24
15.2. Storage Precautions	26
16. Revision History	27

# 1. General Specification

4DLCD-32320240 is a colour active-matrix LCD module incorporating amorphous silicon TFT IPS (Thin Film Transistor). It is composed of a colour TFT-LCD panel, driver IC, FPC and a backlight unit with/without a Resistive/Capacitive Touch Panel (RTP/CTP). The module display area contains 240 x 320 pixels. This product accords with RoHS environmental criteria.

## Part Number Details:

4DLCD 4DLCD LCD Display

32320240 3.2 inches, 240 x 320

Resolution

RTP Resistive touch


CTP Capacitive touch

CLB Cover Lens Bezel



### Note

1. RoHS compliant
2. LCD weight tolerance:  $\pm 5\%$

 Specifications		
ITEM	CONTENTS	UNIT
LCD Type	TFT / Transmissive / Normally white	
Size	3.2	Inch
Viewing Direction	6:00 (without image inversion)	O'Clock
Gray Scale Inversion Direction	12:00	O'Clock
LCD (W x H x T)	4DLCD-32320240: 55.04 x 77.70 x 2.57	mm
	4DLCD-32320240-RTP: 55.04 x 77.70 x 3.57	mm
	4DLCD-32320240-CTP: 55.04 x 77.70 x 5.00	mm
	4DLCD-32320240-CTP-CLB: 72.60 x 98.80 x 4.52 (including CLB)	mm
Active Area (W x H)	48.60 x 64.80	mm
Dot Pitch (W x H)	0.2025 x 0.2025	mm
Number of Dots (Pixels)	240 (RGB) x 320	
Driver IC	ILI9341V	
Backlight Type	6 LEDs	
Surface Luminance	4DLCD-32320240: 200 (typical)	
	4DLCD-32320240-RTP: 160 (typical)	cd/m <sup>2</sup>
	4DLCD-32320240-CTP: 190 (typical)	
	4DLCD-32320240-CTP-CLB: 190 (typical)	
Interface Type	MCU-16bit/SPI	
Colour Depth	262K	
Pixel Arrangement	RGB Vertical Stripe	
Surface Treatment	AG	
Input Voltage	2.8 (typical)	V
With/Without TP (Touch Panel)	4DLCD-32320240 - Without Touch Panel	
	4DLCD-32320240-RTP - With Resistive Touch	
	4DLCD-32320240-CTP - With Capacitive Touch	
	4DLCD-32320240-CTP-CLB - With Capacitive Touch and Cover Lens Bezel	
Weight	4DLCD-32320240: 19.8	

---

ITEM	CONTENTS	UNIT
	4DLCD-32320240-RTP: 28.6	g
	4DLCD-32320240-CTP: 35.0	
	4DLCD-32320240-CTP-CLB: 42.4	

## 2. TFT LCD Display Drawing (Non-Touch Version)

由 Autodesk 教育版产品制作

由 Autodesk 教育版产品制作

由 Autodesk 教育版产品制作

Rev No	Revision note	Date	Signature
1			
2			
3			

PIN	DESCRIP IDN
1	GND
2	END/CSPI
3	IMD
4	EMARK
5	NC
6	RL
7	RESSET
8	RS/CSCLT
9	CS
10	RD
11	WR/WE/CD
12	VCC
13	NC/VSDD
14	GND
15	FB5/GND
16	DB47/GND
17	FB37/GND
18	FB27/GND
19	DB11/GND
20	FB0/GND
21	DB9/GND
22	FB3/GND
23	DB7/GND
24	DB6/GND
25	FB30/GND
26	DB1/GND
27	DB2/GND
28	FB3/GND
29	DB4/GND
30	DB5/GND
31	NC
32	NC
33	LEDA
34	LEDK1
35	LEDK2
36	LEDK3
37	LEDK4
38	LEDK5
39	LEDK6
40	GND

**一. 产品特征 (Features):**

- LCD类型: 3.2" TFT.
- 分辨率 (Resolution): 240\*320
- 显示色彩 (Color): 262K
- 驱动IC (Driver IC): T119341V
- 人眼观察视角 (Viewing Angle): 6 O' CLOCK
- 接口类型 (Interface Types): MCU16-bit/SPI
- 背光类型 (Backlight Types): 6颗LED灯并联.  
电压: 3.2V 电流: 120mA.
- 操作温度 (Operating temperature): -20 C° ~70 C°.
- 储存温度 (Storage temperature): -30 C° ~80 C°.
- 储存湿度 (Storage Humidity): 10RH ~ 40RH.
- 产品所有物料符合ROHS标准 (All materials comply with ROHS standard).
- 建议手机镜片的双面胶不要粘到触摸屏幕胶浆以内, 以免影响TP性能及使用寿命.
- Vands: 模块可视区域, 建议外壳可视区域比Vands单边小0.3mm以上.
- 未注尺寸公差: ±0.2mm

**二. 防静电PCB A设计建议及要求 (The antistatic PCB A design suggestions and requests):**

- 在RESET信号脚上接TVS管, 连接TVS管GND要铺完整
- 信号走线, 如IO, RW, CS, PWDN, RS走在一起, 同时两侧均GND线
- 注意整个PCB走线的完整性 (Note the integrity of the entire PCB grounded).

Limits Unless Otherwise Noted				签名	日期	材料	单位	mm	4D SYSTEMS PTY LTD
Tolerance Grade				设计					
Grade	0	15	30	审核			比例	1:1	客户图号
0 - 150	±0.10	±0.15	±0.20				日期	20190909	工程图号
150+	±0.20	±0.25	±0.30	批准					4DLCD-32240320
Angle	±0.50°	±0.80°		客户确认			投影法		版本
									1.0

### 3. TFT LCD Display Drawing (Resistive Touch Version)

由 Autodesk 教育版产品制作

**一. 产品特征 (Features):**

1. LCD类型: 3.2" TFT.
2. 分辨率 (Resolution): 240\*320
3. 显示色彩 (Color): 262K
4. 驱动IC (Driver IC): T11931LV
5. 人眼观察视角 (Viewing Angle): 6 0' CLOCK
6. 接口类型 (Interface Types): MCU16-bit/SPT .
7. 背光类型 (Backlight Types): 6颗LED灯并联。  
电压: 3.2V 电流: 120mA.
8. 操作温度 (Operating temperature): -20 C° ~70 C° .
9. 储存温度 (Storage temperature): -30 C° ~80 C° .
10. 储存湿度 (Storage Humidity): 10RH ~ 40RH.
11. 产品所有物料符合ROHS标准 (All materials comply with ROHS standard).
12. 建议手机镜片的双面胶不要粘到触摸屏锡浆以内, 以免影响TP性能及使用寿命.
13. Vands: 模块可视区域, 建议外壳可视区域比Vands单边小0.3mm以上.
14. 未注尺寸公差: ±0.2mm

**二. 防静电PCB A设计建议及要求 (The antistatic PCB A design suggestions and requests):**

1. 在RESET信号脚上接TVS管, 连接TVS管GND要铺完整
2. 信号走线, 如IO, CS, PWDEN, BS走在一起, 同时两侧与GND线
3. 注意整个PCB走线的完整性 (Note the integrity of the entire PCB grounded).

**Notes:**

1. Type: Film to Glass
2. Operating Voltage: 10V
3. operation Temperature: -10°C ~60°C  
Storage Temperature: -20°C ~70°C
4. Life Time: ≥ 1,000,000 times
5. Connect Material: FPC
6. Response Time: 10ms
7. Linearity: 1.5%
8. Transmittance: ≥ 90%
9. Surface Hardness: ≥ 3H (Pencil)
10. operation force: 80g ~ 120g
11. Resistance:  
(Clear hard ITO Film): 1500 ~ 5000  
(Stand ard ITO Glass): 350 ~ 850
12. Unspecified Tolerance: ±0.20

Limits Unless Otherwise Noted				签名	日期	材料	mm	4D SYSTEMS PTY LTD
Tolerance Grade				设计		单位		
Grade	0	15	30	绘图		比例	1:1	客户图号
0 - 150	±0.10	±0.15	±0.20	审核		日期	20190909	工程图号
150+	±0.20	±0.25	±0.30	批准				4DLCD-32240320-RTP
Angle	±0.50°	±0.80°		客户确认				投影法
								版本
								1.0

# 4. TFT LCD Display Drawing (Capacitive Touch Version)

**由 Autodesk 教育版产品制作**

由 Autodesk 教育版产品制作

由 Autodesk 教育版产品制作

Rev	Revision note	Date	Signature	Checked
1				
2				
3				

Pin	DESCRIPTION
1	GND
2	VDD/VSPIN
3	VDD
4	MARK
5	STP_IN1
6	STP_SEL
7	RESSET
8	RS/CS/CLT
9	CS
10	RD
11	WR/WE/CD
12	VCC
13	NC/RESSET
14	GND
15	FB5/GND
16	DB47/GND
17	FB37/GND
18	FB27/GND
19	DB11/GND
20	FB0/GND
21	DB9/GND
22	FB8/GND
23	DB7/GND
24	DB6/GND
25	FB0/GND
26	DB1/GND
27	DB2/GND
28	DB3/GND
29	DB4/GND
30	DB5/GND
31	GND
32	GND
33	LE DA
34	LE DK1
35	LE DK2
36	LE DK3
37	LE DK4
38	LE DK5
39	LE DK6
40	GND

**一. 产品特征 (Features):**

- LCD类型: 3.2" TFT.
- 分辨率 (Resolution): 240\*320
- 显示色彩 (Color): 262K
- 驱动IC (Driver IC): T119341V
- 人眼观察视角 (Viewing Angle): 6° CLOCK
- 接口类型 (Interface Types): MCU16-bit/SPI
- 背光类型 (Backlight Types): 6颗LED灯并联.  
电压: 3.2V 电流: 120mA.
- 操作温度 (Operating temperature): -20°C ~ 70°C.
- 储存温度 (Storage temperature): -30°C ~ 80°C.
- 储存湿度 (Storage Humidity): 10RH ~ 40RH.
- 产品所有物料符合ROHS标准 (All materials comply with ROHS standard).
- 建议手机锡片的双面胶不要粘到触摸屏锡浆以内, 以免影响TP性能及使用寿命.
- Vands: 模块可视区域, 建议外壳可视区域比Vands单边小0.3mm以上.
- 未注尺寸公差: ±0.2mm

**二. 防静电PCBA设计建议及要求 (The antistatic PCB A design suggestions and requests):**

- 在RESSET信号脚上接TVS管, 连接TVS管GND要铺完整
- 信号走线, 如DB, CS, FB0-3, RS走在一起, 同时两侧均GND线
- 注意整个PCB走线的完整性 (Note the integrity of the entire PCB grounded).

**BACKLIGHT CIRCUIT DIAGRAM**

**Note:**

- GPIF  
COVER Glass: 0.7mm  
ITO Film: 0.425mm  
Thickness: 1.125±0.1mm  
Drive IC: FT5446
- Operating Voltage: 2.8V-3.3V
- Transmittance: ≥86%
- Hardness: 6H
- Operating TEMP: -10°C ~ +60°C, ≤90%RH
- Storage TEMP: -20°C ~ +70°C, ≤90%RH
- General Tolerance: ±0.2mm

Limits Unless Otherwise Noted				签名	日期	材料	单位	mm	4D SYSTEMS PTY LTD
Tolerance Grade				设计					
Grade	0	1	2	绘图					
0 - 150	±0.10	±0.15	±0.20	审核		比例	1:1	客户图号	
150+	±0.20	±0.25	±0.30	批准		日期	20190909	工程图号	
Angle	±0.50°	±0.80°		客户确认		投影法		版本	
								1.0	



# 5. TFT LCD Display Drawing (Capacitive Touch Version with Cover Lens Bezel)

由 Autodesk 教育版产品制作

由 Autodesk 教育版产品制作

由 Autodesk 教育版产品制作

Rev#	Revision note	Date	Signature	Checked
1				
2				
3				

Pin	DESCRIPTION
1	GND
2	END/CSPI
3	IMD
4	MARK
5	STP_IN
6	STP_SEL
7	RESST
8	RS/CSCL1
9	CS
10	RD
11	WR/CLK
12	VCC
13	NC/SEDD
14	GND
15	FB5/GND
16	DB4/GND
17	FB3/GND
18	FB2/GND
19	DB1/GND
20	FB0/GND
21	DB9/GND
22	DB7/GND
23	DB6/GND
24	DB6/GND
25	FB0/GND
26	DB1/GND
27	DB2/GND
28	DB3/GND
29	DB4/GND
30	DB5/GND
31	C_P_R5
32	C_P_R3A
33	LEDA
34	LEDK1
35	LEDK2
36	LEDK3
37	LEDK4
38	LEDK5
39	LEDK6
40	GND

**一. 产品特征 (Features):**

1. LCD类型: 3.2" TFT.
2. 分辨率 (Resolution): 240\*320
3. 显示色彩 (Color): 262K
4. 驱动IC (Driver IC): T119341V
5. 人眼观察视角 (Viewing Angle): 6 0' CLOCK
6. 接口类型 (Interface Types): MCU16-bit/SPI
7. 背光类型 (Backlight Types): 6颗LED灯并联.  
电压: 3.2V 电流: 120mA.
8. 操作温度 (Operating Temperature): -20°C ~ 70°C
9. 储存温度 (Storage Temperature): -30°C ~ 80°C
10. 储存湿度 (Storage Humidity): 10RH ~ 40RH
11. 产品所有物料符合ROHS标准 (All materials comply with ROHS standard).
12. 建议手机镜片的双面胶不要粘到触摸屏锡浆以内, 以免影响TP性能及使用寿命.
13. Vands: 模块可视区域, 建议外壳可视区域比Vands单边小0.3mm以上.
14. 未注尺寸公差: ±0.2mm

**二. 防静电PCB A设计建议及要求 (The antistatic PCB A design suggestions and requests):**

1. 在RESET信号脚上接TVS管, 连接TVS管GND要铺完整
2. 信号走线, 如IO, CS, PWR, RS走在一起, 同时两侧均GND线
3. 注意整个PCB走线的完整性 (Note the integrity of the entire PCB grounded).

**BACKLIGHT CIRCUIT DIAGRAM**

**Note:**

1. G1F1F  
COVER Glass: 0.7mm  
ITO Film: 0.425mm  
Thickness: 1.125±0.1mm  
Drive IC: FT5446
2. Operating Voltage: 2.8V-3.3V
3. Transmittance: ≥86%
4. Hardness: 6H
5. Operating TEMP: -10°C ~ +60°C, ≤90%RH
6. Storage TEMP: -20°C ~ +70°C, ≤90%RH
7. General Tolerance: ±0.2mm

Limits Unless Otherwise Noted				签名	日期	材料	单位	mm	4D SYSTEMS PTY LTD
Tolerance Grade				设计					
Grade	○			绘图					
0 - 150	±0.10	±0.15	±0.20	审核		比例	1:1	客户图号	
150+	±0.20	±0.25	±0.30	批准		日期	20190909	工程图号	
Angle	±0.50°	±0.80°		客户确认		投影法		版本	
								1.0	


## 6. Absolute Maximum Ratings

Absolute Maximum Ratings				
PARAMETER	SYMBOL	MIN	MAX	UNIT
Supply Voltage for LCD Logic	VDD/VCC	-0.3	4.6	V
Input Voltage for Logic	VIN	VSS-0.5	VDD	V
LED forward current (each LED)	IF	-	25	mA
Operating Temperature	TOP	-20	70	°C
Storage Temperature	TST	-30	80	°C
Humidity	RH	-	90% (Max 60°C)	RH

## 7. Electrical Characteristics

Electrical Characteristics					
PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT
Power Voltage (Logic)	VDD/DCC	2.6	2.8	3.3	V
Input Current (Logic)	IVDD	-	13	-	mA
Input Voltage 'H' Level	VIH	0.7 VDD	-	VDD	V
Input Voltage 'L' Level	VIL	0	-	0.3 VDD	V

## 8. Electro-Optical Characteristics

 Electro-Optical Characteristics							
ITEM	SYM	CONDITION	MIN	TYP	MAX	UNIT	REMARK
Response Time	Tr+Tf	$\theta=0$	-	30	-	ms	see figure
Contrast Ratio	Cr	$^{\circ}$	-	250	-	-	see figure
Luminance Uniformity	$\delta$ WHITE	$\varnothing=0$	75	80	-	%	see figure
Surface Luminance	Lv	4DLCD-32320240	180	200	-	cd/m2	see figure
		4DLCD-32320240-RTP	144	160	-		
		4DLCD-32320240-CTP	175	194	-		
		4DLCD-32320240-CTP-CLB	175	194	-		
Viewing Angle Range	$\theta$	$\varnothing = 90^{\circ}$	-	35	-	deg	see figure
		$\varnothing = 270^{\circ}$	-	55	-	deg	
		$\varnothing = 0^{\circ}$	-	55	-	deg	
		$\varnothing = 180^{\circ}$	-	55	-	deg	
CIE (x,y) Cromacity - Red	x		0.574	0.624	0.674		
	y		0.318	0.368	0.418		
CIE (x,y) Cromacity - Green	x	$\theta=0^{\circ}$	0.300	0.350	0.400		
	y	$\varnothing=0^{\circ}$	0.500	0.550	0.600		see figure
CIE (x,y) Cromacity - Blue	x	Ta=25	0.093	0.143	0.193		
	y		0.069	0.119	0.169		
CIE (x,y) Cromacity - White	x		0.260	0.310	0.360		
	y		0.283	0.333	0.383		

## 9. Backlight Characteristics



### Backlight Characteristics

PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT
Voltage for LED backlight (Each LED)	V <sub>I</sub>	-	3.2	3.4	V
Current for LED backlight (Each LED)	I <sub>I</sub> -each	-	20	25	mA
Current for LED backlight (Total - 4 LEDs)	I <sub>I</sub>	-	120	150	mA
LED Lifetime (50% of original brightness)	-	30000	-	-	Hrs



### Note

The LED lifetime is defined as the module brightness decreasing to 50% original brightness at Ta=25°C.

1. Contrast Ratio(CR) is defined mathematically as below, for more information see [figure](#).

$$\text{Contrast Ratio} = \frac{\text{Average Surface Luminance with all white pixels (P1, P2, P3, P4, P5)}}{\text{Average Surface Luminance with all black pixels (P1, P2, P3, P4, P5)}}$$

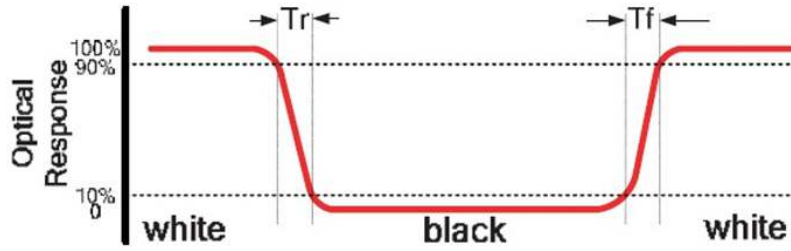
2. Surface luminance is the LCD surface from the surface with all pixels displaying white. For more information, see [Figure 2](#).

$$L_v = \text{Average Surface Luminance with all white pixels (P1, P2, P3, P4, P5)}$$

3. The uniformity in surface luminance  $\delta$  WHITE is determined by measuring luminance at each test position 1 through 5, and then dividing the maximum luminance of 5 points luminance by the minimum luminance of 5 points luminance. For more information, see [figure](#).

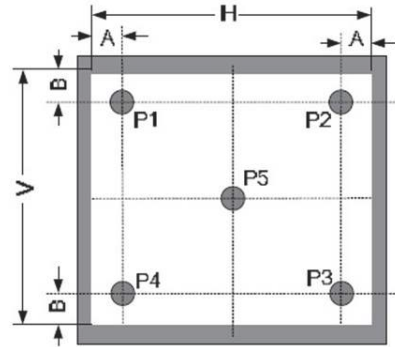
$$\delta^{\text{WHITE}} = \frac{\text{Minimum Surface Luminance with all white pixels (P1, P2, P3, P4, P5)}}{\text{Maximum Surface Luminance with all white pixels (P1, P2, P3, P4, P5)}}$$

4. Response time is the time required for the display to transition from white to black (Rise Time, Tr) and from black to white (Decay Time, Tf). For additional information see [Figure 1](#). The test equipment is the Autronic-Melchers ConoScope series.
5. CIE (x, y) chromaticity, the x and y value is determined by measuring luminance at each test position 1 through 5, and then making the average value.
6. Viewing angle is the angle at which the contrast ratio is greater than 2. For the TFT module, the contrast ratio is greater than 10. The angles are determined for the horizontal or x-axis and the vertical or y-axis to the z-axis which is normal to the LCD surface. For more information, see [figure](#).
7. For viewing angle and response time testing, the testing data is based on the Autronic-Melchers ConoScope series. Instruments for Contrast Ratio, Surface Luminance, Luminance Uniformity, and CIE the test data is based on TOPCONS BM-5 photodetector.

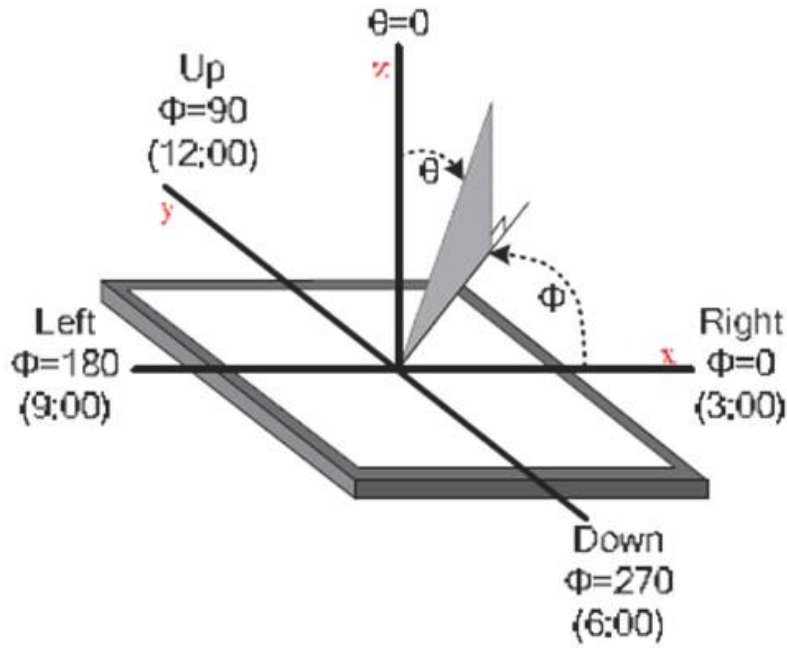


The definition of response time

A : 5 mm  
 B : 5 mm  
 H, V : Active Area  
 Light spot size  $\varnothing=5\text{mm}$ , 500mm distance from the LCD surface to detector lens  
 measurement instrument is TOPCON's luminance meter BM-5



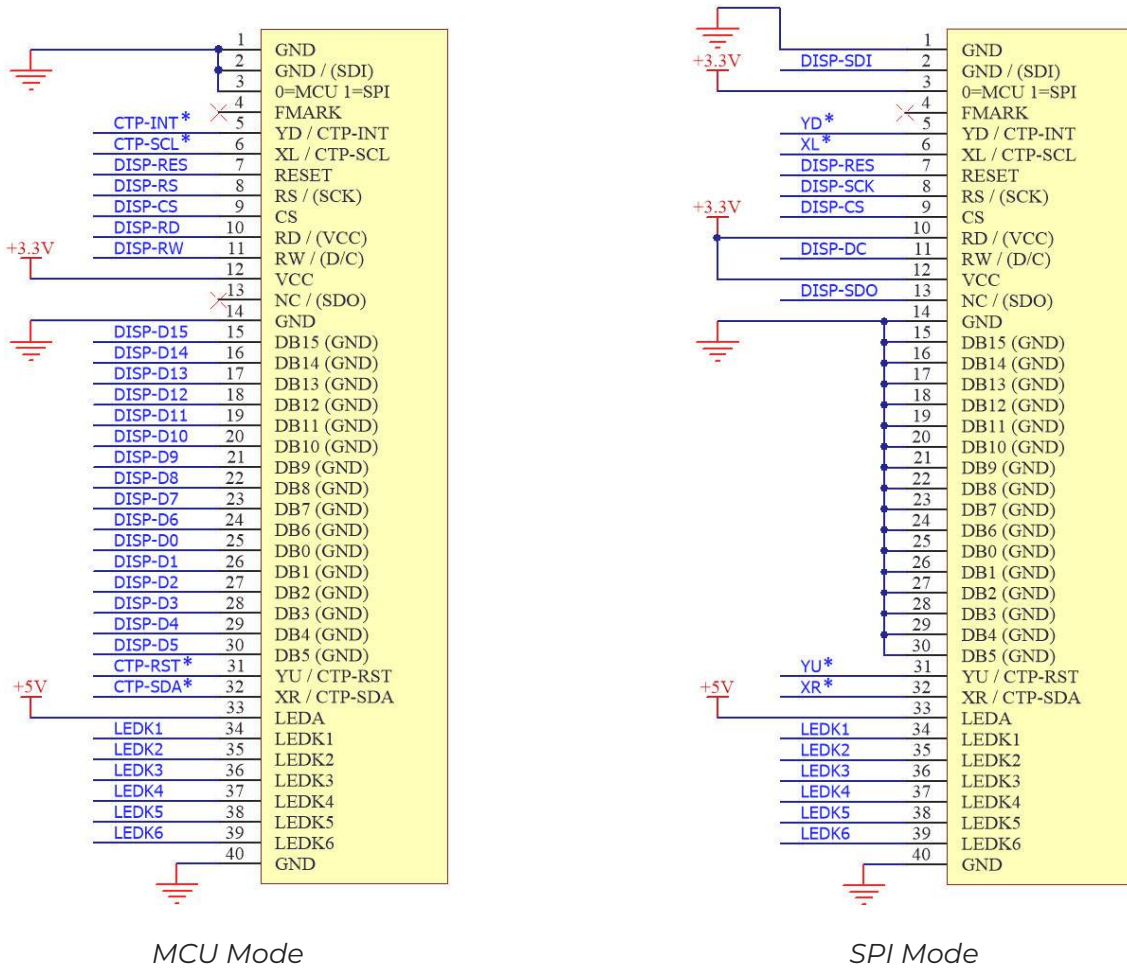
Measuring method for Contrast ratio, surface luminance, Luminance uniformity, CIE (x, y) chromaticity



The definition of viewing angle

# 10. Interface Descriptions

## 10.1. LCD Interface




\* This has no connection (NC) for Non-touch displays.

PIN NO.	SYMBOL	DESCRIPTION	REMARK
1	GND	Ground	
2	GND/(SDI)	Ground for MCU mode/ Serial Data Input signal for SPI mode	
3	MODE	MCU-16bit /SPI mode selection pin	Note 1
4	FMARK	Tearing effect output signal	
5	YD/CTP_INT	The touch panel Y bottom pin for RTP / Interrupt signal from CTP/No Connection (NC) for Non touch Version	Note 3
6	XL/CTP_SCL	The touch panel X left pin for RTP/ I2C SCL for CTP / No Connection (NC) for Non touch Version	Note 3
7	RESET	Reset input signal	

PIN NO.	SYMBOL	DESCRIPTION	REMARK
8	RS/SCL	Instruction Register/Data Register selection pin for MCU mode / SPI Serial Clock for SPI mode	
9	CS	Chip select input pin	
10	RD/(VCC)	Read signal for MCU mode / Tie to VCC for SPI mode	
11	WR/(D/C)	Write signal for MCU mode / Data or Command selection for SPI mode	
12	VCC	Power supply (Logic)	
13	NC/(SDO)	No Connect for MCU mode / Serial Data Output for SPI mode	
14	GND	Ground	
15	DB15/(GND)	Databus DB15 for MCU mode / Tie to GND for SPI mode	Note 2
16	DB14/(GND)	Databus DB14 for MCU mode / Tie to GND for SPI mode	Note 2
17	DB13/(GND)	Databus DB13 for MCU mode / Tie to GND for SPI mode	Note 2
18	DB12/(GND)	Databus DB12 for MCU mode / Tie to GND for SPI mode	Note 2
19	DB11/(GND)	Databus DB11 for MCU mode / Tie to GND for SPI mode	Note 2
20	DB10/(GND)	Databus DB10 for MCU mode / Tie to GND for SPI mode	Note 2
21	DB9/(GND)	Databus DB9 for MCU mode / Tie to GND for SPI mode	Note 2
22	DB8/(GND)	Databus DB8 for MCU mode / Tie to GND for SPI mode	Note 2
23	DB7/(GND)	Databus DB7 for MCU mode / Tie to GND for SPI mode	Note 2
24	DB6/(GND)	Databus DB6 for MCU mode / Tie to GND for SPI mode	Note 2
25	DB0/(GND)	Databus DB0 for MCU mode / Tie to GND for SPI mode	Note 2
26	DB1/(GND)	Databus DB1 for MCU mode / Tie to GND for SPI mode	Note 2
27	DB2/(GND)	Databus DB2 for MCU mode / Tie to GND for SPI mode	Note 2
28	DB3/(GND)	Databus DB3 for MCU mode / Tie to GND for SPI mode	Note 2
29	DB4/(GND)	Databus DB4 for MCU mode / Tie to GND for SPI mode	Note 2
30	DB5/(GND)	Databus DB5 for MCU mode / Tie to GND for SPI mode	Note 2
31	YU/CTP_RST	The touch panel Y up pin for RTP / Reset pin for CTP / No Connection (NC) for Non touch Version	Note 3
32	XR/CTP_SDA	The touch panel X right pin for RTP / I2C SDA Pin for CTP / No Connection (NC) for Non touch Version	Note 3
33	LEDA	Anode of LED Backlight	
34	LEDK1	Cathode1 of LED Backlight	
35	LEDK2	Cathode2 of LED Backlight	

PIN NO.	SYMBOL	DESCRIPTION	REMARK
36	LEDK3	Cathode3 of LED Backlight	
37	LEDK4	Cathode4 of LED Backlight	
38	LEDK5	Cathode5 of LED Backlight	
39	LEDK6	Cathode6 of LED Backlight	
40	GND	Ground	

 **Note**

## 1. Interface Mode Selection (pin 3)

Value	Interface	Remark
0	MCU 16bit	Databus:DB0~DB15
1	SPI	4 wire SPI Mode

2. Pins 15 to 30 are grounded on SPI mode.

3. Pins 5,6,31 and 32 are only applicable to touchscreen displays (4DLCD-xxxxxxx-RTP/CTP).

## 10.2. CTP Interface

The Capacitive Touch is driven by a **Focaltech FT5446** capacitive touch driver IC, which utilizes an I2C interface, and is capable of 5-point touch.



## 11. Backlight Example Circuit

The backlight circuit can be easily driven off a 5V supply. The voltage needs to be higher than the forward voltage of the LEDs and other drops in the circuit, which can be found in the [Interface Descriptions](#) section. A 3.3V supply typically does not meet this requirement, so a 5V supply is normally used.

In this circuit, a simple transistor is used to switch each of the LEDs on, where each LED is current-limited through its resistor. The transistor base can be PWM'ed if required (Label BACKLIGHT below), to give dimming control. An example PWM frequency that could be used is 3Khz, however, it is up to the Designer to determine what is suitable for the application.

The resistance feeding each LED can be calculated using Ohms Law,  $V=I \times R$ .

We want to calculate R, so  $R=V/I$

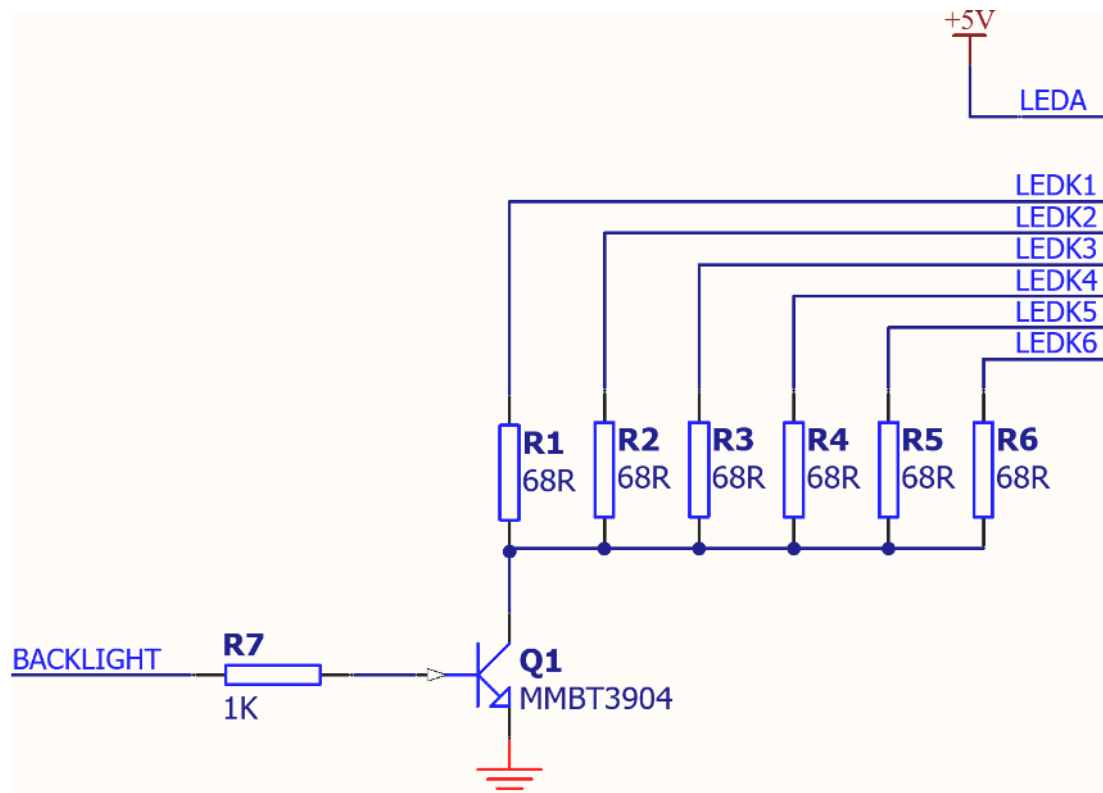
Supply Voltage = 5V

LED Forward Voltage = 3.2V (see the [Interface Descriptions](#) section)

Estimated voltage drop over transistor = 0.3V

Target current per LED = 20mA to 25mA (use 22mA in this example) (See the [Interface Descriptions](#) section)

Formula is then  $R = (5V - 3.2V - 0.3V) / 0.022A = 68\text{ohms}$  for each LED (LEDK1 to LEDK6)



## 12. Initialisation Code

```
//***** Hardware reset *****//

LCD_RESET = 1;
Delaysms(15);
LCD_RESET = 0;
Delaysms(120);
LCD_RESET = 1;
Delaysms(120);

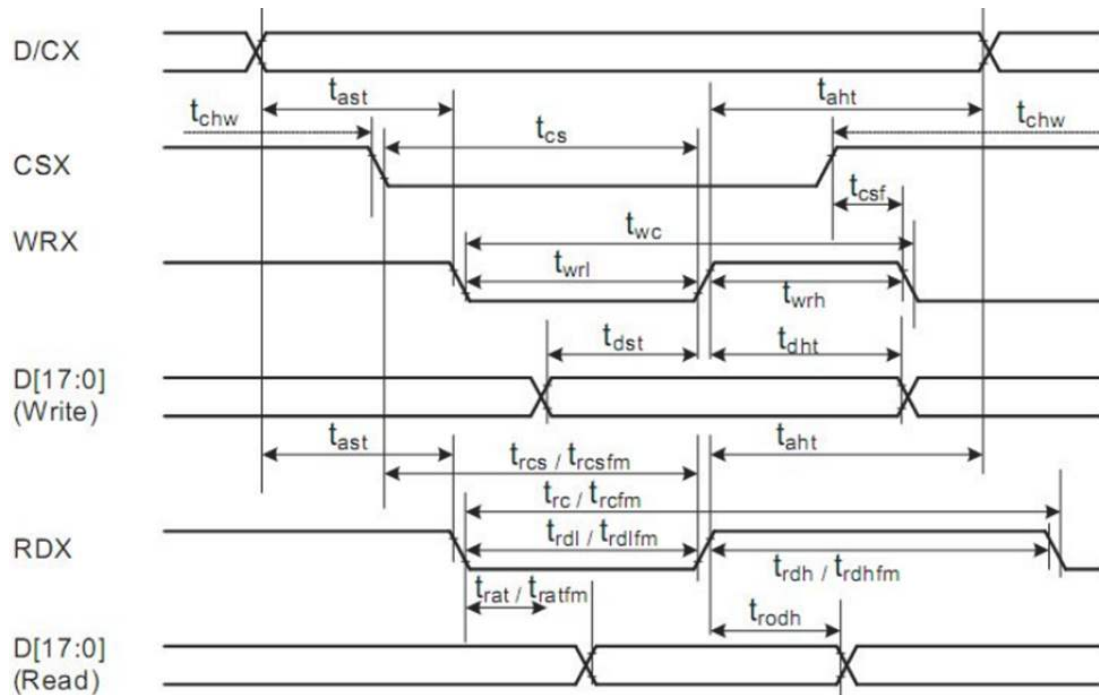
//***** Start Initial Sequence *****//

write_reg(0xCF);
write_dat(0x00);
write_dat(0x83);
write_dat(0x30);
write_reg(0xED);
write_dat(0x64);
write_dat(0x03);
write_dat(0x12);
write_dat(0x81);
write_reg(0xCB);
write_dat(0x39);
write_dat(0x2C);
write_dat(0x00);
write_dat(0x34);
write_dat(0x02);
write_reg(0xEA);
write_dat(0x00);
write_dat(0x00);
write_reg(0xE8);
write_dat(0x85);
write_dat(0x10);
write_dat(0x79);
write_reg(0xC0); // Power control
write_dat(0x23); // VRH[5:0]
write_reg(0xC1); // Power control
write_dat(0x11); // SAP[2:0];BT[3:0]
write_reg(0xC2);
write_dat(0x11);
write_reg(0xC5); // VCM control
write_dat(0x3D);
write_dat(0x30);
write_reg(0xC7); // VCM control2
write_dat(0XAA);
write_reg(0x3A);
write_dat(0x55);
write_reg(0x36); // Memory Access Control
write_dat(0x08);
write_reg(0xB1);
write_dat(0x00);
write_dat(0x11);
write_reg(0xB6); // Display Function Control
write_dat(0x0A);
write_dat(0xA2);
write_reg(0xF2); // 3Gamma Function Disable
write_dat(0x00);
write_reg(0XF7);
```

```
write_dat(0x20);
write_reg(0XF1);
write_dat(0x01);
write_dat(0x30);
write_reg(0x26);
write_dat(0x01);
write_reg(0xE0); // Set Gamma
write_dat(0x0F);
write_dat(0x3F);
write_dat(0x2F);
write_dat(0x0C);
write_dat(0x10);
write_dat(0x0A);
write_dat(0x53);
write_dat(0XD5);
write_dat(0x40);
write_dat(0x0A);
write_dat(0x13);
write_dat(0x03);
write_dat(0x08);
write_dat(0x03);
write_dat(0x00);
write_reg(0XE1); // Set Gamma
write_dat(0x00);
write_dat(0x00);
write_dat(0x10);
write_dat(0x03);
write_dat(0x0F);
write_dat(0x05);
write_dat(0x2C);
write_dat(0XA2);
write_dat(0x3F);
write_dat(0x05);
write_dat(0x0E);
write_dat(0x0C);
write_dat(0x37);
write_dat(0x3C);
write_dat(0x0F);
write_reg(0x11); // Exit Sleep
Delays(120);
write_reg(0x29); // Display on
```

## 13. LCD Timing Details

### 13.1. Timing Chart

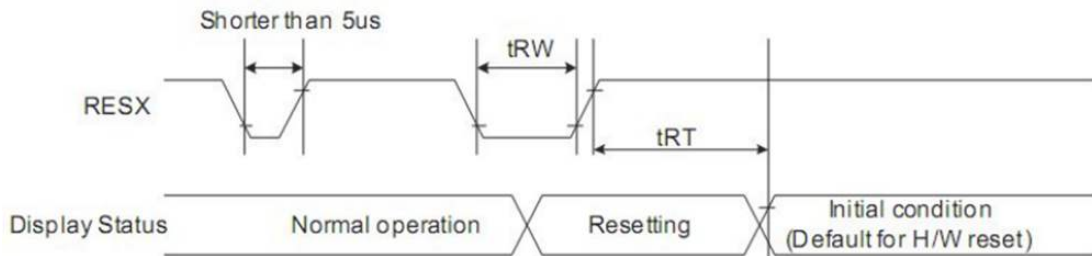


SIGNAL	SYMBOL	PARAMETER	MIN	MAX	UNIT
DCX	$t_{ast}$	Address setup time	0	-	ns
	$t_{ah}$	Address hold time (Write/Read)	0	-	ns
CSX	$t_{chw}$	CSX "H" pulse width	0	-	ns
	$t_{cs}$	Chip Select setup time	15	-	ns
	$t_{rcs}$	Chip Select setup time (Read ID)	45	-	ns
	$t_{rcsfm}$	Chip Select setup time (Read FM)	355	-	ns
	$t_{csf}$	Chip Select Wait time (Write/Read)	10	-	ns
WRX	$t_{wc}$	Write cycle	66	-	ns
	$t_{wrh}$	Write Control Pulse H duration	15	-	ns
	$t_{wrl}$	Write Control Pulse L duration	15	-	ns
RDX(FM)	$t_{rcfm}$	Read cycle (FM)	450	-	ns
	$t_{rdhfm}$	Read Control Pulse H duration (FM)	90	-	ns

SIGNAL	SYMBOL	PARAMETER	MIN	MAX	UNIT
	trdlfm	Read Control Pulse L duration (FM)	355	-	ns
RDX(ID)	trc	Read cycle (ID)	160	-	ns
	trdh	Read Control Pulse H duration	90	-	ns
	trdl	Read Control Pulse L duration	45	-	ns
D[17:0]	tdst	Write data setup time	10	-	ns
	tdht	Write data hold time	10	-	ns
	trat	Read access time	-	40	ns
	Tratfm	Read access time	-	340	ns
	trod	Read output disable time	20	80	ns

**Note**  
 Timing parameter (VDD=3.3V, GND=0V, Ta=25°C)

### 13.2. Reset Timing



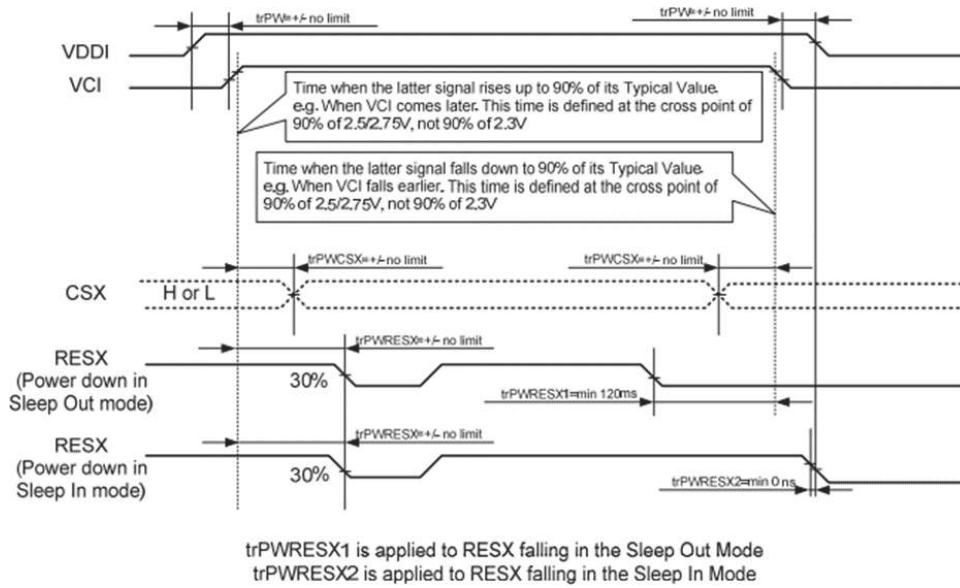
SIGNAL	SYMBOL	PARAMETER	MIN	MAX	UNIT
RESET	$t_{RW}$	Reset low pulse width	10	-	us
	$t_{RT}$	Reset complete time	-	5 (note1)	ms
			-	120 (note2)	ms

**Note**

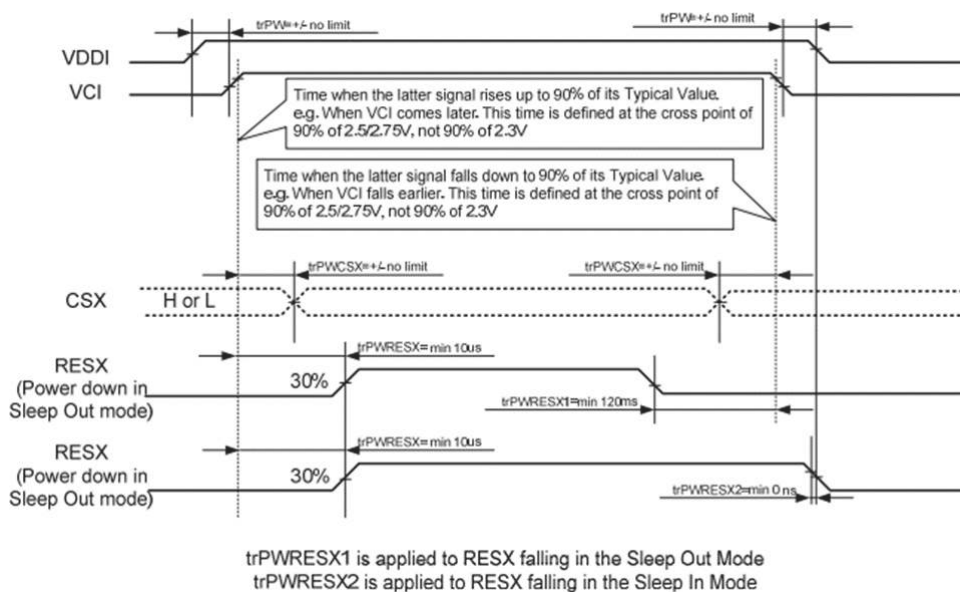
1. When reset is applied during SLPIN mode.
2. When reset is applied during SLPOUT mode.

### 13.3. Power On Sequence

#### 13.3.1. Case 1 - RES line is held High or Unstable by Host at Power ON



#### 13.3.2. Case 2 - RES line is held Low by Host at Power ON



### 13.4. Power-off Sequence - Uncontrolled Power Off

Uncontrolled power off is a situation where power is removed unexpectedly, e.g. a battery powering a device is disconnected without using the controlled power off sequence. There will not be any damage to the display module, nor will the display module cause any damage to the host. During an uncontrolled power-off event, ILI9341V will force the display to blank its content and there will not be any further abnormal visible effects on the display after 1 second of the power being removed. The display will remain blank until the Power On Sequence occurs.

## 14. Reliability Test

 Reliability Test			
No.	SYMBOL	TEST CONDITION	REMARK
1	High Temperature Storage	80°C±2°C 96H Restore 2H at 25°C Power off	
2	Low Temperature Storage	-30°C±2°C 96H Restore 2H at 25°C Power off	
3	High Temperature Operation	70°C±2°C 96H Power on	
4	Low Temperature Operation	-20°C±2°C 96H Power on	
5	High Temperature & Humidity Operation	60°C±2°C 90%RH 96H Power on	After test cosmetic and electrical defects should not happen.
6	Temperature Cycle	-20°C↔25°C↔70°C 30min 5min 30min After 10 cycles, restore 2H at 25°C Power off	
7	Vibration Test	10Hz~150Hz, 100m/s <sup>2</sup> , 120min	
8	Shock Test	Half-sinewave, 300m/s <sup>2</sup> , 11ms	

### Note

The Displays are of the highest rated 'Grade A', which allows for 0-4 defective pixels. A defective pixel could be solid Black (Dead), White, Red, Green or Blue.

## 15. Precautions for Using LCD Modules

### 15.1. Handling Precautions

- The display panel is made of glass and a polarizer. The glass is fragile. It tends to be chipped during handling, especially on the edges. Please avoid dropping or jarring. Please be careful not subject it to a mechanical shock by dropping it on impact.
- If the display panel is damaged and the liquid crystal substance leaks out, be sure not to get any of it in your mouth. If the substance contacts your skin or clothes, wash it off using soap and water.
- Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary. Do not touch the display with bare hands. This will stain the display area and degrade insulation between terminals (some cosmetics are determined by the polarizer).
- The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully. Do not touch, push or rub the exposed polarizer with anything harder than an HB pencil lead (e.g., glass, tweezers, etc.). Do not put or attach anything to the display area to avoid leaving marks on it. Condensation on the surface and contact with terminals due to cold temperatures will damage, stain or contaminate the polarizer. After products are tested at low temperatures they must be warmed up in a container before coming into contact with room-temperature air.
- If the display surface becomes contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If it is heavily contaminated, moisten the cloth with one of the following solvents
  - Isopropyl alcohol
  - Ethyl alcohol Do not scrub hard as it might damage the display surface.
- Solvents other than those mentioned above may damage the polarizer. Especially the following.
  - Water
  - Ketone
  - Aromatic solvents Wipe off saliva or water drops immediately, contact with water over a long period may cause deformation or color fading. Avoid contact with oil and fat.
- Take necessary precautions to minimize corrosion of the electrode. Corrosion of the electrodes is accelerated by water droplets, moisture condensation or current flow in a high-humidity environment.
- Install the LCD Module by using the mounting holes. When mounting the LCD module, make sure it is free of twisting, warping and distortion. In particular, do not forcibly pull or bend the I/O cable or the backlight cable.
- Do not attempt to disassemble or process the LCD module.
- NC terminal should be open. Do not connect anything to it.
- If the logic circuit power is off, do not apply input signals.



- Control Electro-Static Discharge. Since this module uses a CMOS LSI, the same careful attention should be paid to electrostatic discharge as for an ordinary CMOS IC. To prevent the destruction of the elements by static electricity, ensure that an optimum work environment is maintained.
  - Before removing the LCM from its packing case or incorporating it into a set, be sure that the module and your body have the same electric potential. Be sure to ground your body when handling the LCD modules.
  - To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions. To reduce the generation of static electricity, please ensure that the air in the work environment is not too dry. Relative humidity of 50%-60% is recommended. As much as possible, make the electric potential of your work clothes and that of the workbench the ground potential.
  - The LCD module is coated with a film to protect the display surface. Be careful when peeling off this protective film since static electricity may be generated.
- Since the LCM has been assembled and adjusted with a high degree of precision, avoid applying excessive shocks to the module or making any alterations or modifications to it.
  - Do not alter, modify or change the shape of the tab on the metal frame.
  - Do not make extra holes on the printed circuit board, modify its shape or change the positions of the components to be attached.
  - Do not damage or modify the pattern writing on the printed circuit board.
  - Do not modify the zebra rubber strip (conductive rubber) or heat seal connector.
  - Do not drop, bend or twist the LCM.


---

## 15.2. Storage Precautions

When storing the LCD modules, the following precautions are necessary.

- Store them in a sealed polyethylene bag. If properly sealed, there is no need for the desiccant.
- Store them in a dark place. Do not expose to sunlight or fluorescent light, keep the temperature between 0°C and 35°C, and keep the relative humidity between 40%RH and 60%RH.
- The polarizer surface should not come in contact with any other objects. We advise you to store them in the anti-static electricity container in which they were shipped. Some Liquid crystals solidify under low temperatures (below the storage temperature range) leading to defective orientation or the generation of air bubbles (black or white). Air bubbles may also be generated if the module is subjected to low temperatures.
- If the LCD modules have been operating for a long time showing the same display patterns, the display patterns may remain on the screen as ghost images and a slight contrast irregularity may also appear. A normal operating status can be regained by suspending use for some time. It should be noted that this phenomenon does not adversely affect performance reliability.
- To minimize the performance degradation of the LCD modules resulting from the destruction caused by static electricity etc., please avoid holding the following sections when handling the modules'
  - The exposed area of the printed circuit board
  - Terminal electrode sections

## 16. Revision History

 Revision History			
REVISION	DATE	COMMENT	REMARKS
1.0	01/07/2019	Initial Version	Initial Version
1.1	22/08/2020		
1.2	24/06/2021	Added logic current consumption data, added backlight circuit example	
1.3	20/01/2023	Modified datasheet for web-based documentation	